

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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### MOS FIELD EFFECT TRANSISTOR

**Phase-out/Discontinued**

# μ PA2711GR

## SWITCHING P-CHANNEL POWER MOS FET

### DESCRIPTION

The μ PA2711GR is P-Channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

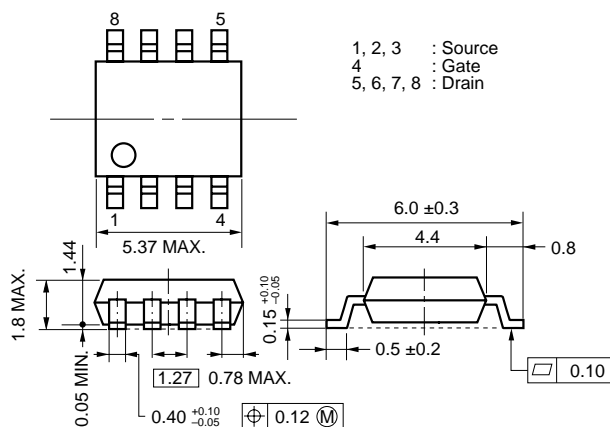
### FEATURES

- Low on-state resistance  
 $R_{DS(on)1} = 9 \text{ m}\Omega \text{ MAX. (} V_{GS} = -10 \text{ V, } I_D = -6.5 \text{ A)}$   
 $R_{DS(on)2} = 15 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.5 \text{ V, } I_D = -6.5 \text{ A)}$   
 $R_{DS(on)3} = 20 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.0 \text{ V, } I_D = -6.5 \text{ A)}$
- Low  $C_{iss}$ :  $C_{iss} = 2450 \text{ pF TYP.}$
- Small and surface mount package (Power SOP8)

### ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA2711GR	Power SOP8

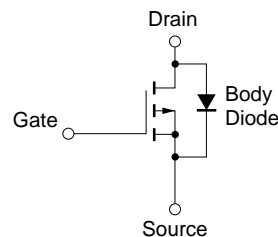
### PACKAGE DRAWING (Unit: mm)



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ , Unless otherwise noted, All terminals are connected.)

Drain to Source Voltage ( $V_{GS} = 0 \text{ V}$ )	$V_{DSS}$	-30	V
Gate to Source Voltage ( $V_{DS} = 0 \text{ V}$ )	$V_{GSS}$	±20	V
Drain Current (DC)	$I_{D(DC)}$	±13	A
Drain Current (pulse) <sup>Note1</sup>	$I_{D(pulse)}$	±52	A
Total Power Dissipation <sup>Note2</sup>	$P_{T1}$	2	W
Total Power Dissipation <sup>Note3</sup>	$P_{T2}$	2	W
Channel Temperature	$T_{ch}$	150	°C
Storage Temperature	$T_{stg}$	-55 to + 150	°C
Single Avalanche Current <sup>Note4</sup>	$I_{AS}$	-13	A
Single Avalanche Energy <sup>Note4</sup>	$E_{AS}$	16.9	mJ

### EQUIVALENT CIRCUIT



**Notes 1.**  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$

**2.** Mounted on ceramic substrate of  $1200 \text{ mm}^2 \times 2.2 \text{ mm}$

**3.** Mounted on a glass epoxy board (1 inch x 1 inch x 0.8 mm),  $PW = 10 \text{ sec}$

**4.** Starting  $T_{ch} = 25^\circ\text{C}$ ,  $V_{DD} = -15 \text{ V}$ ,  $R_G = 25 \Omega$ ,  $L = 100 \mu\text{H}$ ,  $V_{GS} = -20 \rightarrow 0 \text{ V}$

**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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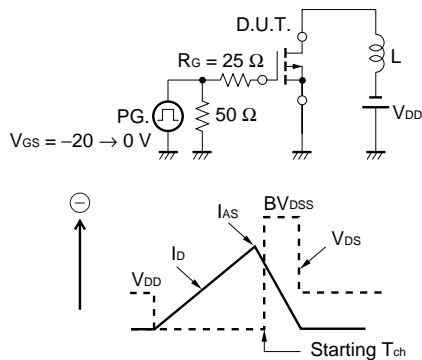
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**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, Unless otherwise noted, All terminals are connected.)**

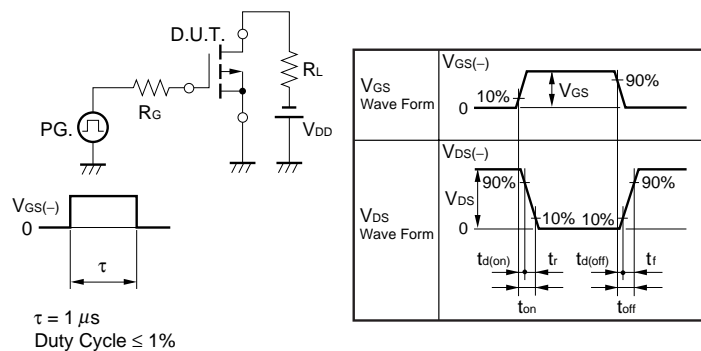
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I <sub>bss</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V			-1	μA
Gate Leakage Current	I <sub>gss</sub>	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±100	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-1.0		-2.5	V
Forward Transfer Admittance <span style="font-size: small;">Note</span>	y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -6.5 A	10	22		S
Drain to Source On-state Resistance <span style="font-size: small;">Note</span>	R <sub>DS(on)1</sub>	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -6.5 A		7.4	9	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -6.5 A		10	15	mΩ
	R <sub>DS(on)3</sub>	V <sub>GS</sub> = -4.0 V, I <sub>D</sub> = -6.5 A		12	20	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10 V		2450		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V		740		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		410		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -15 V, I <sub>D</sub> = -6.5 A		10		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = -10 V		15		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 10 Ω		230		ns
Fall Time	t <sub>f</sub>			130		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -24 V		57		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -10 V		6.3		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -13 A		19		nC
Body Diode Forward Voltage <span style="font-size: small;">Note</span>	V <sub>F(S-D)</sub>	I <sub>F</sub> = 13 A, V <sub>GS</sub> = 0 V		0.81		V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 13 A, V <sub>GS</sub> = 0 V		62		ns
Reverse Recovery Charge	Q <sub>rr</sub>	di/dt = 50 A/μs		31		nC

**Note** Pulsed

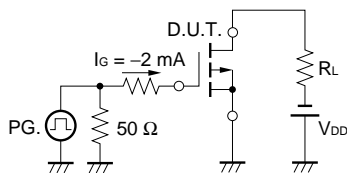
**TEST CIRCUIT 1 AVALANCHE CAPABILITY**



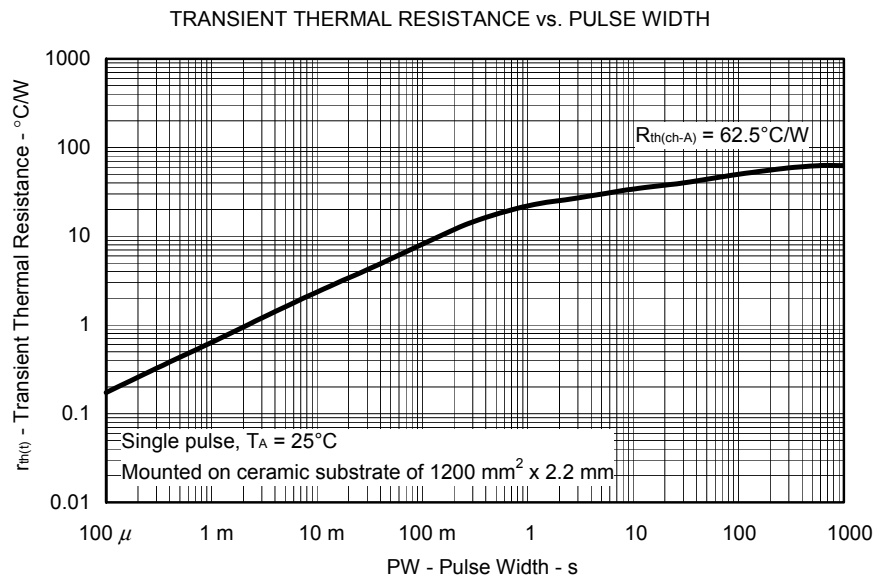
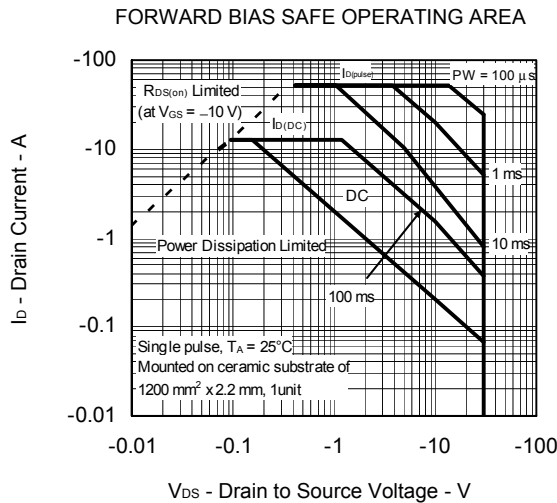
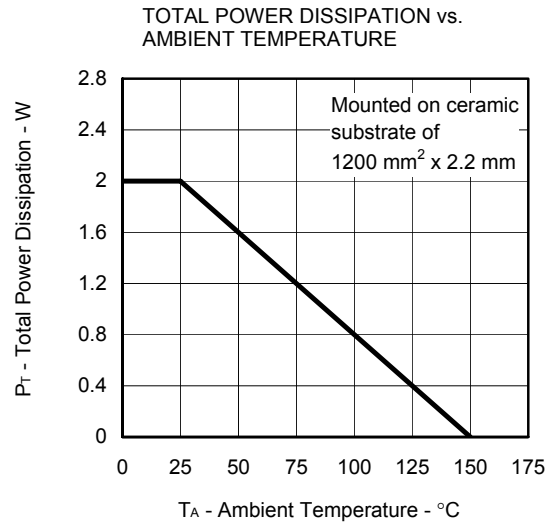
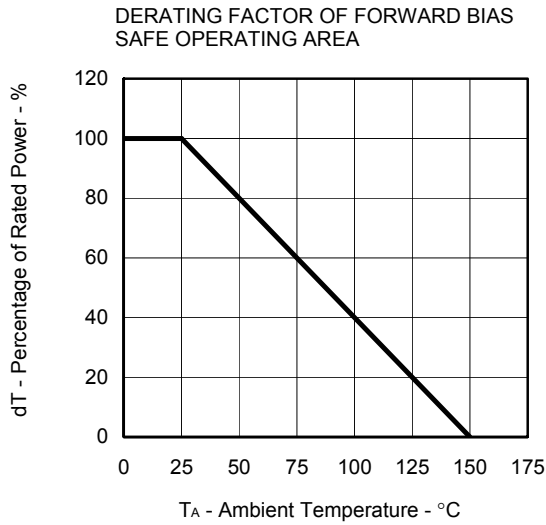
**TEST CIRCUIT 2 SWITCHING TIME**



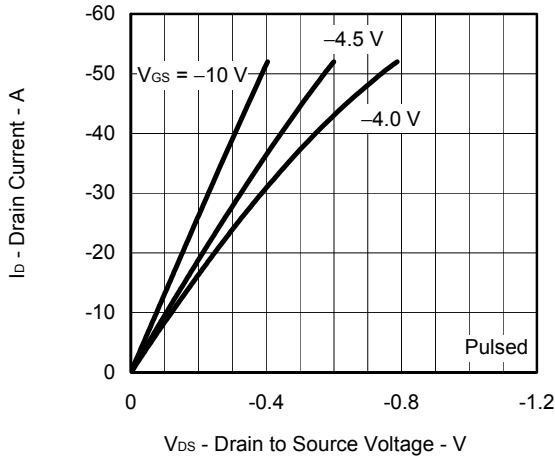
**TEST CIRCUIT 3 GATE CHARGE**



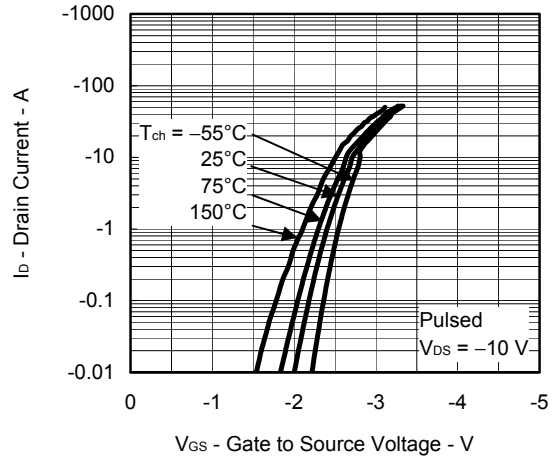
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)**



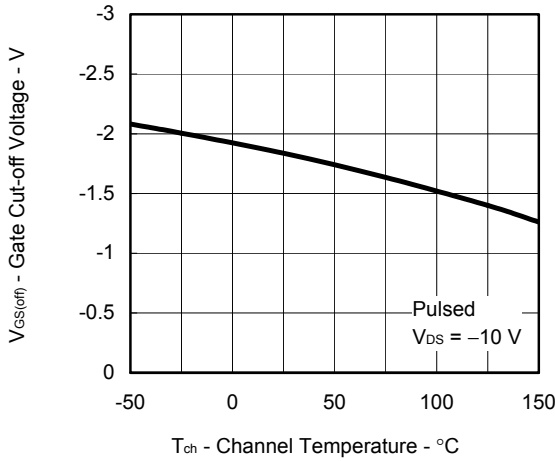
**DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE**



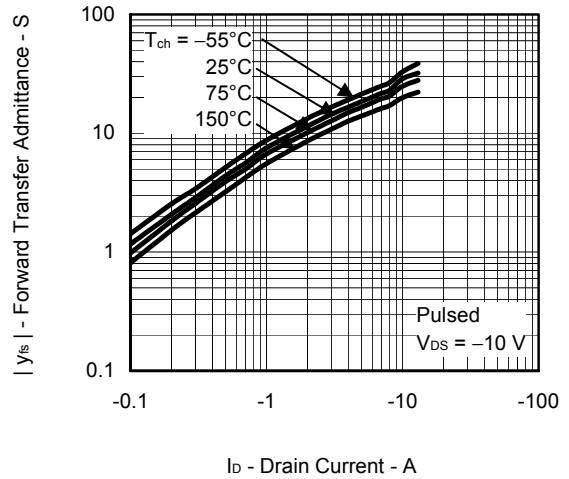
**FORWARD TRANSFER CHARACTERISTICS**



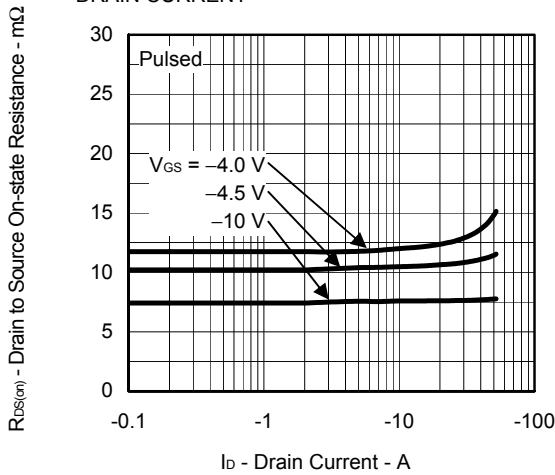
**GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE**



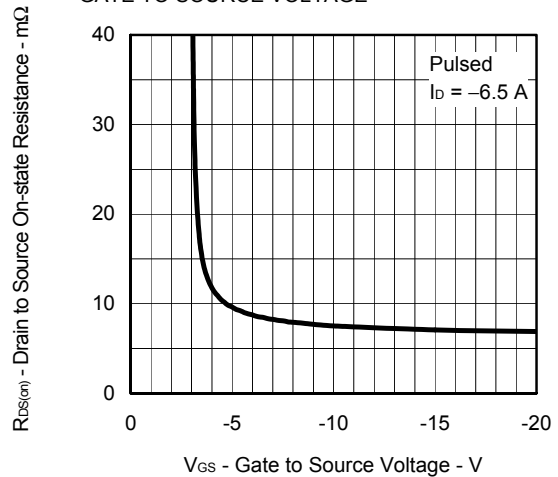
**FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT**

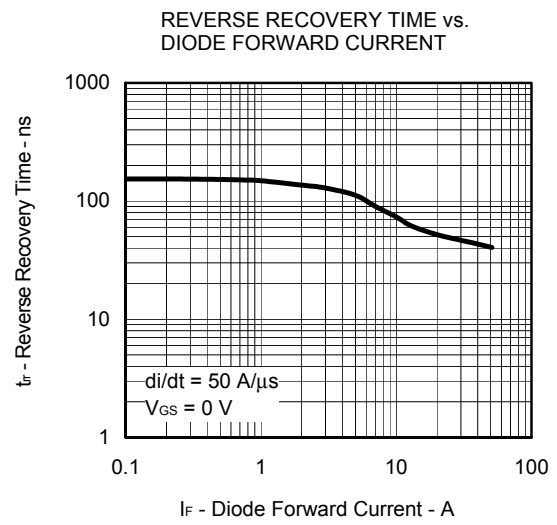
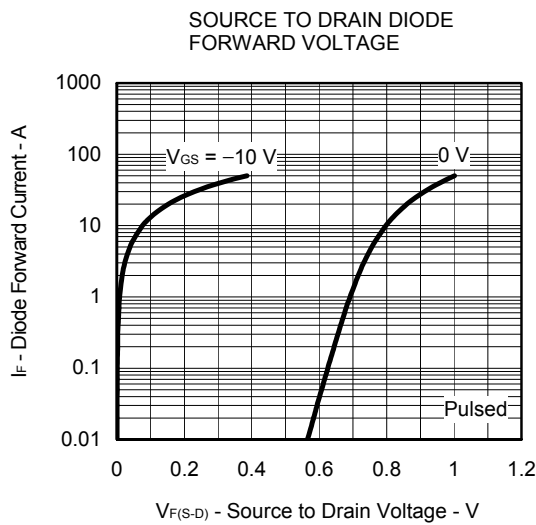
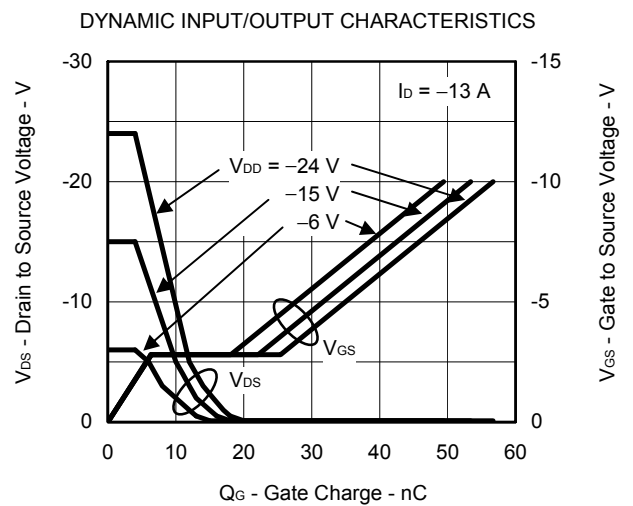
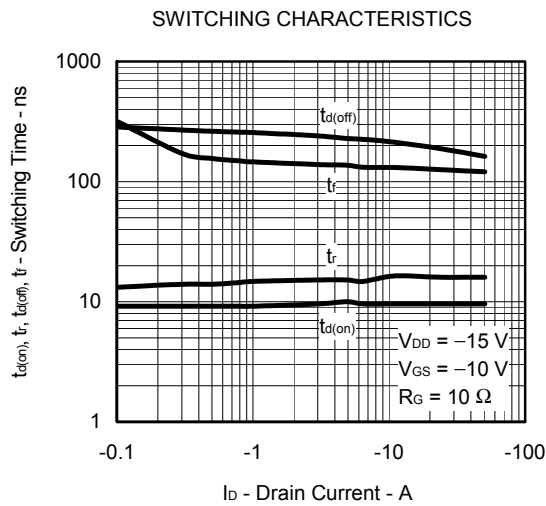
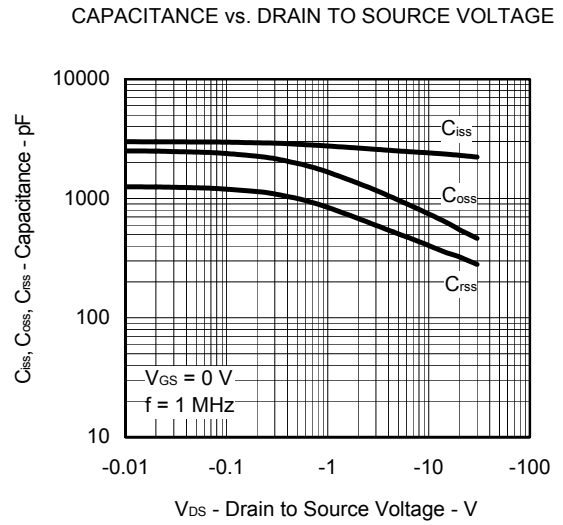
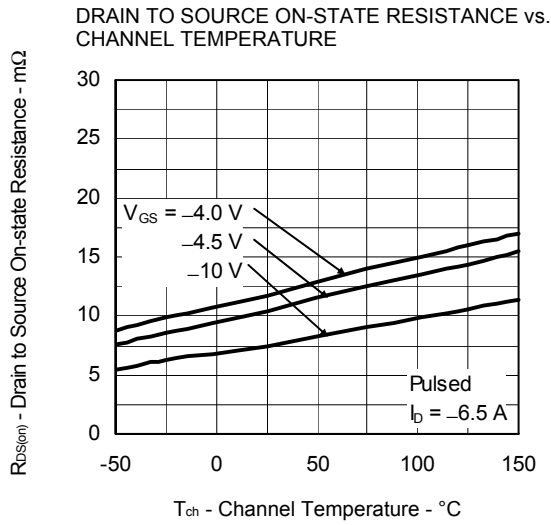


**DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT**

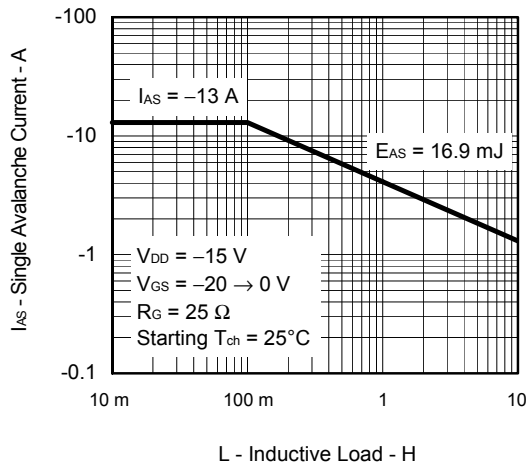


**DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE**

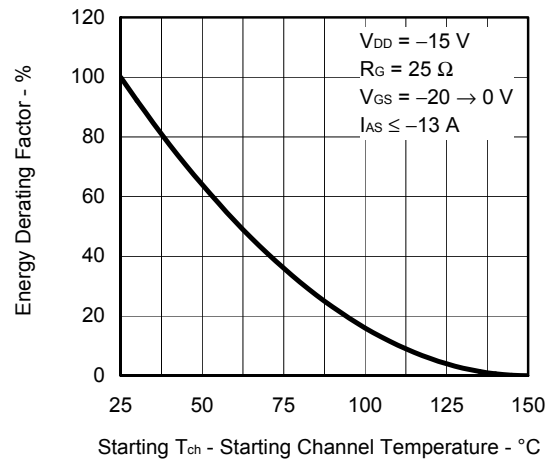




SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY DERATING FACTOR





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